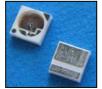


## LED34-HIGH-SMD3

#### **TECHNICAL DATA**



## Mid-Infrared Light Emitting Diode, SMD

Light Emitting Diodes with central wavelength 3.40  $\mu$ m series are based on heterostructures grown on InAs substrates by MOCVD. InAs is used in the active layer. Wide band gap solid solutions InAsSbP with P content 50% are used for god electron confinement.

LED34-HIGH-SMD3 has a stable ouput power and a lifetime more then 80000 hours.

#### **Features**

Structure: InAsSb/InAsSbP
Peak Wavelength: typ. 3.40 μm

Optical Ouput Power: typ. 65 μW qCW

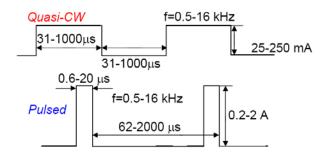
Package: SMD 3x3 mm



#### **Specifications**

Item	Condition		Rating	1	Unit
		Min.	Тур.	Max.	
Peak Wavelength	T=300 K	3.30	3.40	3.49	μm
FWHM	150 mA CW	300	400	500	nm
Quasi-CW Optical Power	200 mA qCW	45	65	80	mW
Pulsed Optical Power	1 A	480	600	720	mW
Switching Time	T=300 K	10	20	30	ns
Operation Voltage	200 mA qCW				V
Operating Temperature	-240 +50 °C			°C	
Emitting Area	300x300 μm			μm	
Soldering Temperature	180 °C			°C	
Package	SMD type package 3x3 mm based on high thermal conductivity ceramics				igh

#### **Operating Regime**



#### **Quasi-CW**

- Maximum current 220 mA
- Recommended current 150-200mA

#### **Pulsed**

 Maximum current 1 A (puls lenght 500 ns, repetition rate 2kHz)



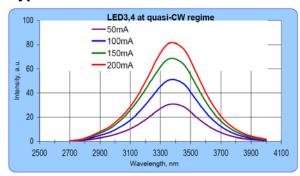
# ROITHNER LASERTECHNIK GIRDH

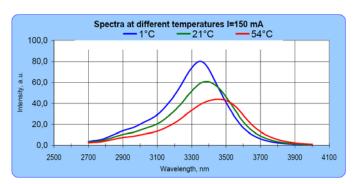
WIEDNER HAUPTSTRASSE 76

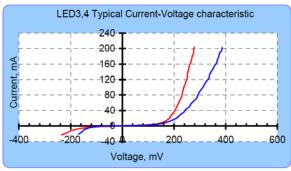
1040 VIENNA TEL. +43 I 586 52 43 -0, FAX. -44, OFFICE@ROITHNER-LASER.COM

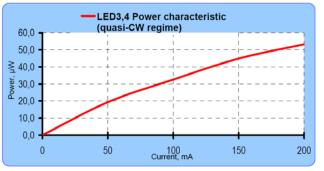


### **Typical Performance Curves**

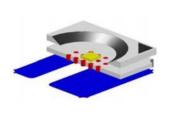


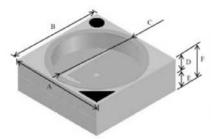






#### **Package**





ITEM	Symbol	Rule	
Basic Outline	A	3.0± 0.1mm	
Basic Outline	В	3.0± 0.1mm	
Cavity size	C	Max 2.4Φ	
Top layer	D	Min 0.4mm	
Bottom layer	E	Min 0.4mm	
Thickness	F	Max 2mm	

- · Tiny package for surface mounting
- · Anode and cathode are led to the metalized areas on the back side of the ceramic surface
- Material Low Temperature Co-fired Ceramic (LTCC):
  - thermal conductivity 25 W/mK
  - thermoresistance 8 °C/W